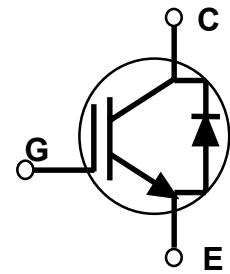


**FEATURES**

- \* High Speed Switching
- \* Low Saturation Voltage  
:  $V_{CE}(\text{sat}) = 2.0 \text{ V}$  (at  $I_c=60\text{A}$ )
- \* High Input Impedance
- \* Built in Fast Recovery Diode

**TO-264****APPLICATIONS**

- \* Home Appliance
  - Induction Heater
  - IH JAR
  - Micro Wave Oven

**ABSOLUTE MAXIMUM RATINGS**

<b>Symbol</b>	<b>Characteristics</b>		<b>Rating</b>	<b>Unit</b>
$V_{CES}$	Collector-Emitter Voltage		900	V
$V_{GE}$	Gate - Emitter Voltage		$\pm 25$	V
$I_c$	Continuous Collector Current	$T_c = 25^\circ\text{C}$	60	A
		$T_c = 100^\circ\text{C}$	42	
$I_{CM(1)}$	Pulsed Collector Current		120	A
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ\text{C}$	180	W
		$T_c = 100^\circ\text{C}$	72	
$T_j$	Operating Junction Temperature		$-55 \sim 150$	$^\circ\text{C}$
$T_{stg}$	Storage Temperature Range			
$T_L$	Soldering maximum lead temperature (1/8" from case for 10 seconds)		300	$^\circ\text{C}$

**Notes:**(1) Repetitive rating : Pulse with limited by max. junction temperature

# SGL60N90DG3

N-CHANNEL IGBT

## ELECTRICAL CHARACTERISTICS (T<sub>C</sub>=25°C)

Symbol	Characteristics	Test Conditions	Min	Typ	Max	Units
BV <sub>CES</sub>	C - E Breakdown Voltage	V <sub>GE</sub> = 0V , I <sub>C</sub> = 1mA	900	-	-	V
V <sub>GE(th)</sub>	G - E threshold voltage	I <sub>C</sub> = 60mA , V <sub>CE</sub> = V <sub>GE</sub>	4.0	5.0	7.0	V
I <sub>CES</sub>	Collector cutoff Current	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0V	-	-	1.0	mA
I <sub>GES</sub>	G - E leakage Current	V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0V	-	-	500	nA
V <sub>CE(sat)</sub>	Collector to Emitter saturation voltage	V <sub>GE</sub> = 15V, I <sub>C</sub> = 60A	-	2.0	2.7	V
Cies	Input capacitance	V <sub>GE</sub> = 0V , f = 1MHz V <sub>CE</sub> = 10V	-	6500	-	pF
Coes	Output capacitance		-	250	-	pF
Cres	Reverse transfer capacitance		-	220	-	pF
td(on)	Turn on delay time	V <sub>CC</sub> = 600V , I <sub>C</sub> = 60A V <sub>GE</sub> = 15V R <sub>G</sub> = 51Ω Resistive load	-	250	400	ns
tr	Rise time		-	450	700	ns
td(off)	Turn off delay time		-	450	700	ns
tf	Fall time		-	250	400	ns
V <sub>EC</sub>	Emitter-Collector Voltage	I <sub>E</sub> = 15A	-	1.2	1.7	V
trr	Reverse recovery time	I <sub>E</sub> = 15A, dI/dt = -200A/μs	-	0.5	2.5	μs

## THERMAL RESISTANCE

Symbol	Characteristics	Min	Typ	Max	Units
R <sub>θ</sub> JC	Junction-to-Case : IGBT	-	-	0.69	°C/W
R <sub>θ</sub> JC	Junction-to-Case : Diode	-	-	2.08	°C/W

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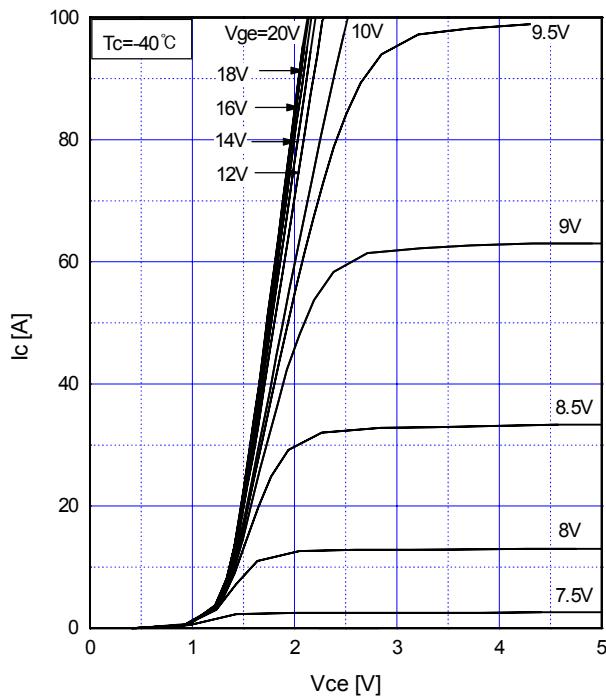


Fig.1 Typical Output Characteristics

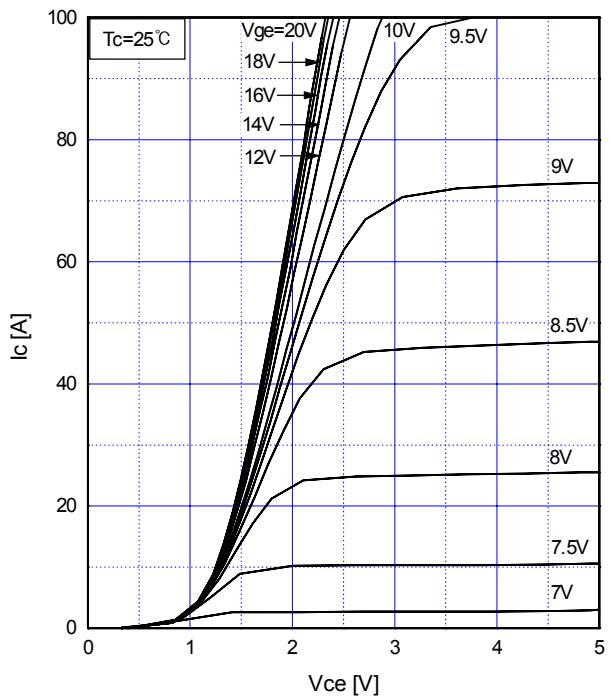


Fig.2 Typical Output Characteristics

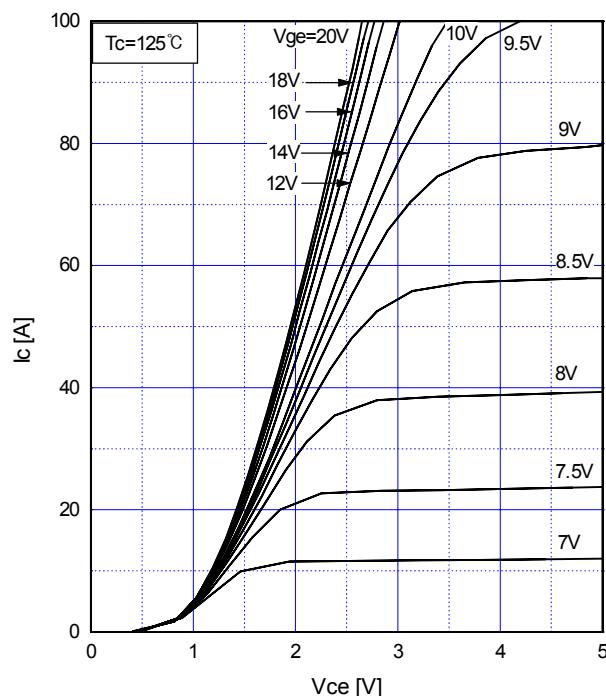


Fig.3 Typical Output Characteristics

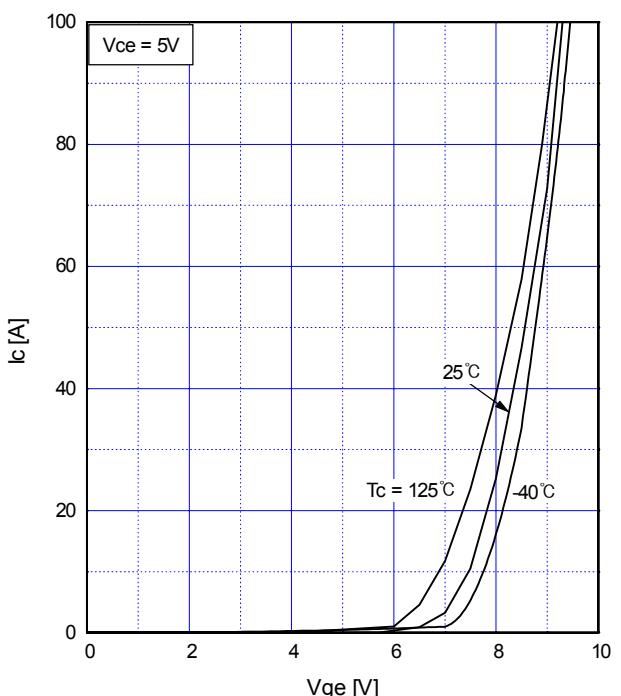


Fig.4 Typical Output Characteristics

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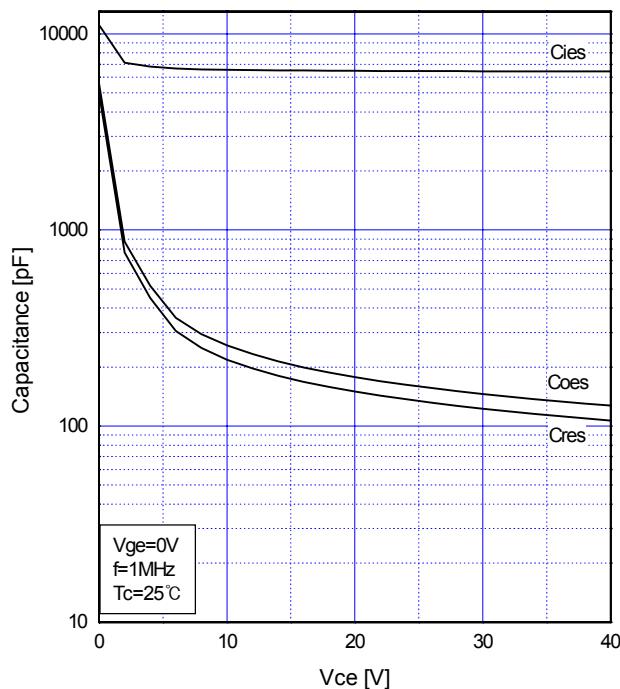


Fig.5 Typical Capacitance vs.  
Collector to Emitter Voltage

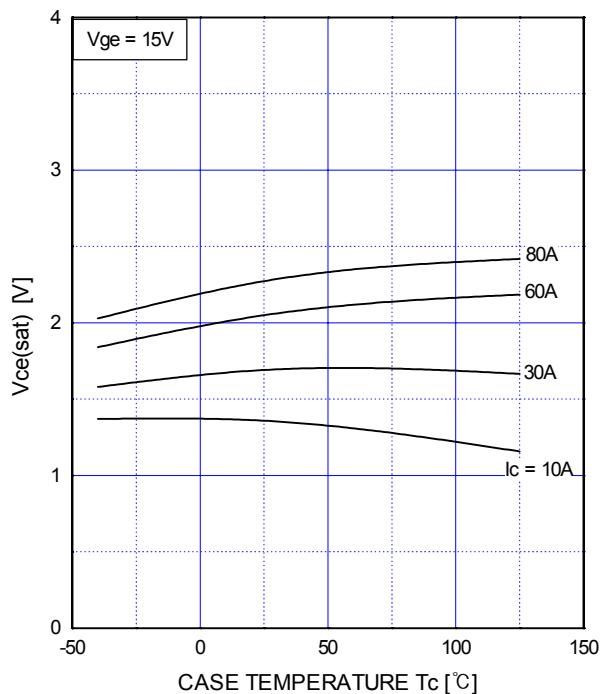


Fig.6 Collector to Emitter Saturation  
Voltage vs. Case Temperature

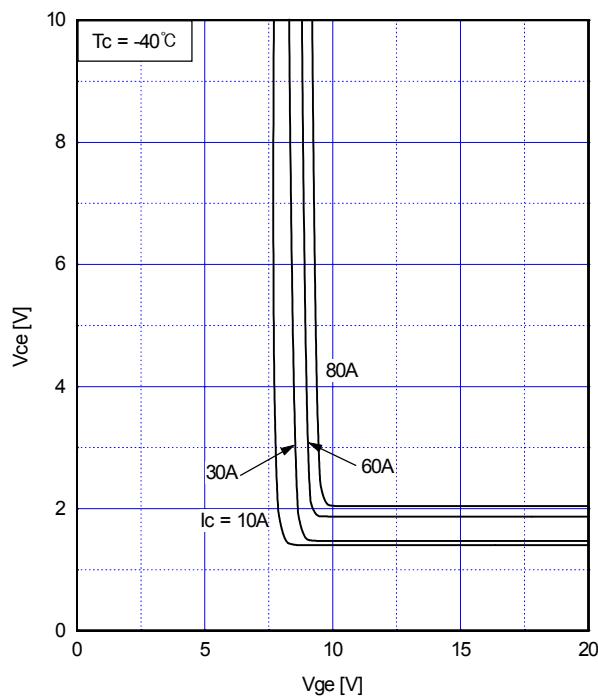


Fig.7 Collector to Emitter Voltage  
vs. Gate to Emitter Voltage

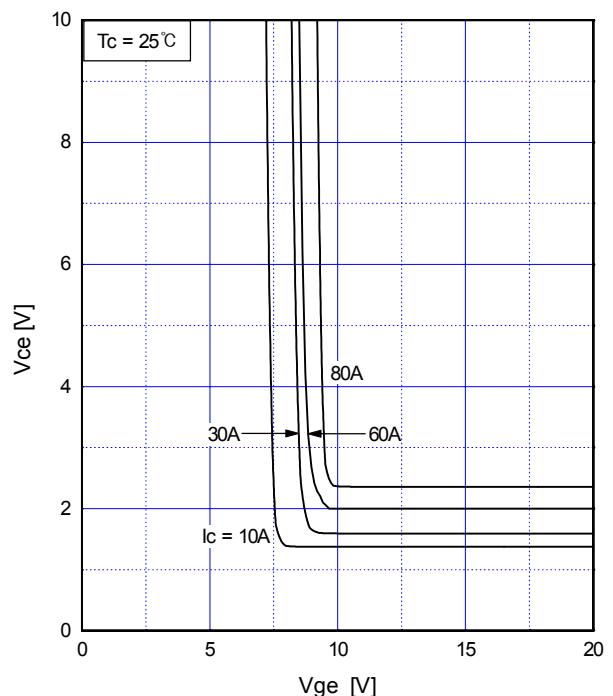


Fig.8 Collector to Emitter Voltage  
vs. Gate to Emitter Voltage

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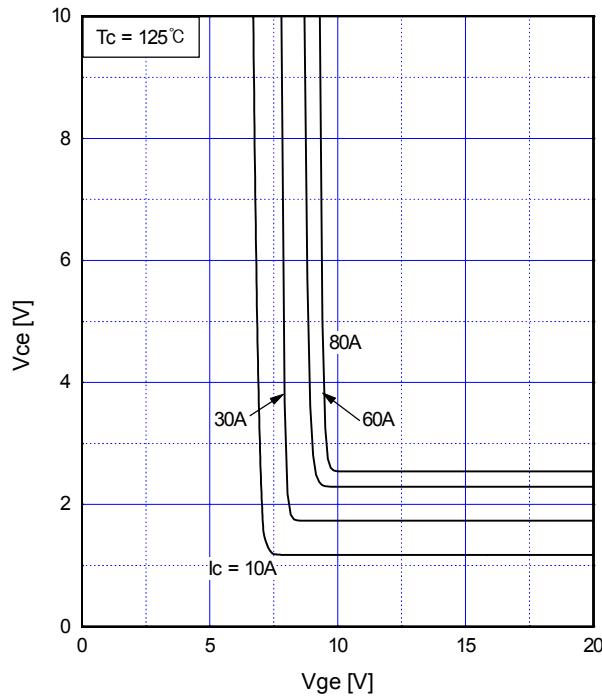


Fig.9 Collector to Emitter Voltage vs. Gate to Emitter Voltage

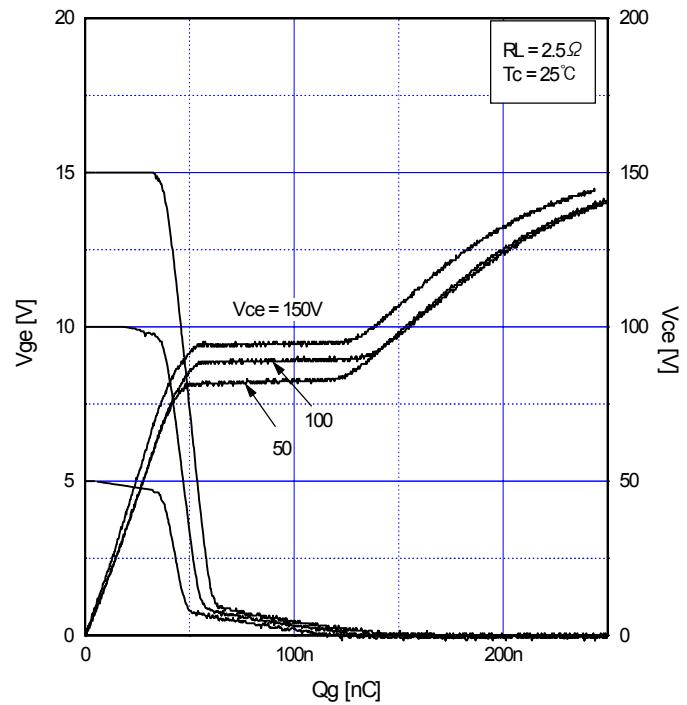


Fig.10 Gate Charge

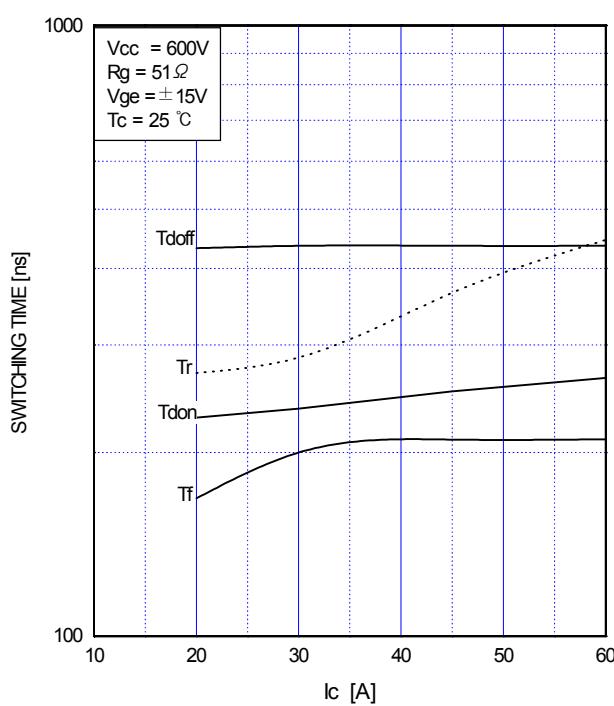


Fig.11 Collector Current vs. Switching time

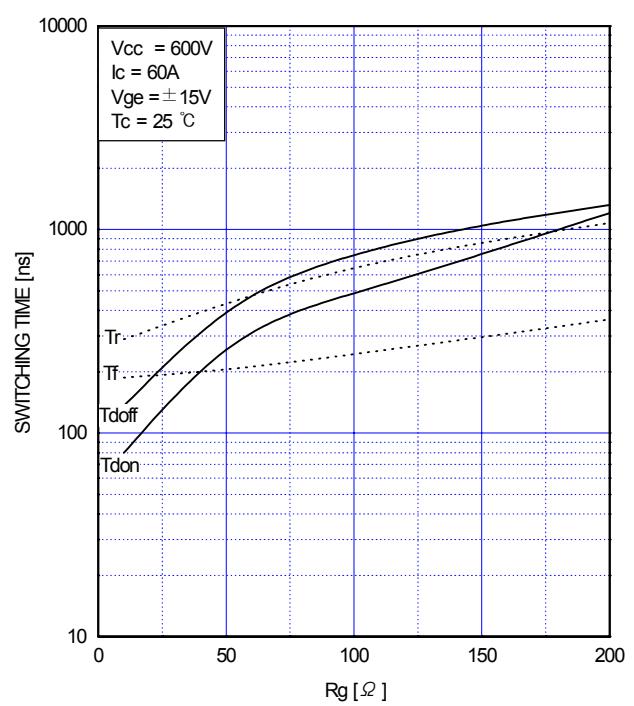


Fig.12 Gate Resistance vs. Switching time



ELECTRONICS

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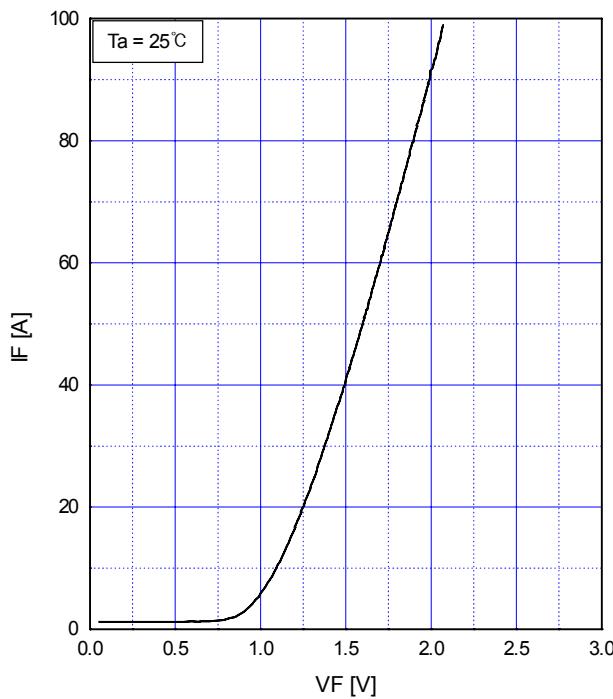


Fig.13 Emitter to Collector Forward Voltage Characteristics

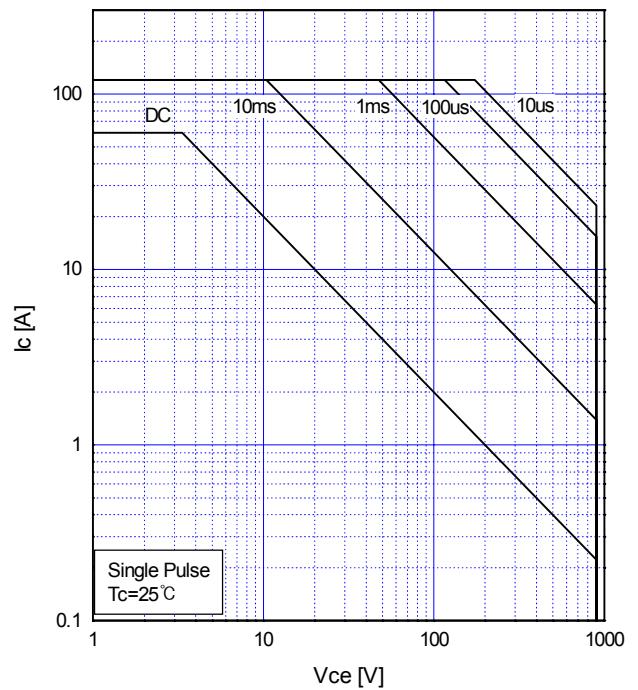


Fig.14 Safe Operating Area

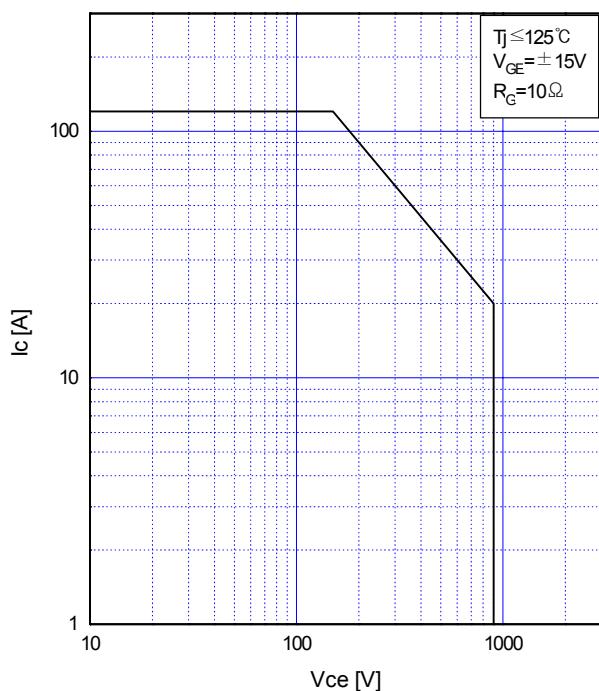


Fig.15 Reverse Bias SOA